ASSOCIATION C	ONNECTING NDUSTRIES® MOUSTRIES®	C, Bannockb	urn, Illinois. A	Il rights reserved un ntions.	nder both	This docume level parts, t	ent is a declarat	ion of the su	ubstances s all lower	within the manufactur level materials for w	er listed i hich the n	tem. Note: i nanufacturer	f the item is an as r has engineering	sembly with lower responsibility.
1752-21.1					Form Type Distribute	 Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater 				als and Mfg Information				
Supplier I	nformation													
Company name*			Company unique ID				Unique ID Authority				Response Date*			
onsemi											2025-06-06			
Contact Nan	ne	Title - Contact				Phone - Contact*				Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized I	Representative*	Title - Representative				Phone - Representative*				Email - Representative*				
Product-En	v-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
F	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	Effective Date Version Manufacturing Site		Ianufacturing Site		Weight*	UOM	Unit Type
		2SB1123	2SB1123S-TD-E BIP PNI		IP PNP 2A 50V		2025-06-06		C	CNG		51.38	mg	Each
Manufact	uring Proccess Informati	ion												
Te	Terminal Plating / Grid Array Material Te			erminal Base Alloy J-STD-020 MSL			Peak Process Body Temperature Max Time at Pea			Temperature Number of Reflow Cycles				
contains Bi CU All			U Alloy	lloy 1			260 C 30			seconds 3				
Comments														
evel 1 - max	imum time at peak temperatur	re during sol	dering is 10-3	0 seconds										
For more inf	formation regarding material c	composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chro	S Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl late (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.33	mg	Supplier	Silicon (Si)	7440-21-3		0.33	mg
Die Attach Solder	0.15	mg	Supplier	Silver (Ag)	7440-22-4		0.0038	mg
			А	Lead (Pb)	7439-92-1	7a	0.1388	mg
			Supplier	Tin (Sn)	7440-31-5		0.0075	mg
ead Frame	22.4	mg	Supplier	Silver (Ag)	7440-22-4		0.0986	mg
			Supplier	Tin (Sn)	7440-31-5		0.0314	mg
			Supplier	Copper (Cu)	7440-50-8		22.2701	mg
Iold Compound-Black	27.65	mg		Brominated epoxy resin	proprietary data		0.3871	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		1.2443	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.2488	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2765	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		20.7375	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		4.7005	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.0553	mg
lating	0.77	mg	В	Bismuth (Bi)	7440-69-9		0.0046	mg
			Supplier	Tin (Sn)	7440-31-5		0.7654	mg
Wire Bond - Au	0.08	mg	Supplier	Gold (Au)	7440-57-5		0.08	mg